8-bit serial-in/parallel-out shift register

Rev. 1 — 5 July 2013

Product data sheet

1. General description

The 74AHC164-Q100; 74AHCT164-Q100 shift register is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7A.

The 74AHC164-Q100; 74AHCT164-Q100 input signals are 8-bit serial through one of two inputs (DSA or DSB). Either input can be used as an active HIGH enable for data entry through the other input. Both inputs must be connected together or an unused input must be tied HIGH.

Data shifts one place to the right on each LOW-to-HIGH transition of the clock input (CP). It enters into output Q0, which is a logical AND of the two data inputs (DSA and DSB). These data inputs existed one set-up time, prior to the rising clock edge.

A LOW-level on the master reset (\overline{MR}) input overrides all other inputs and clears the register asynchronously, forcing all outputs LOW.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Balanced propagation delays
- All inputs have Schmitt-trigger actions
- Inputs accept voltages higher than V_{CC}
- Input levels:
 - For 74AHC164-Q100: CMOS level
 - ◆ For 74AHCT164-Q100: TTL level
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

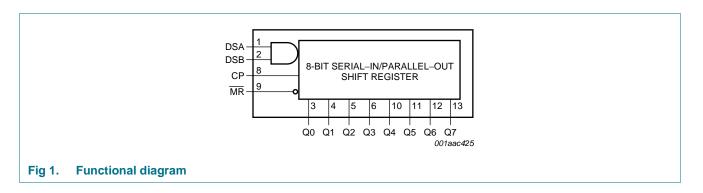


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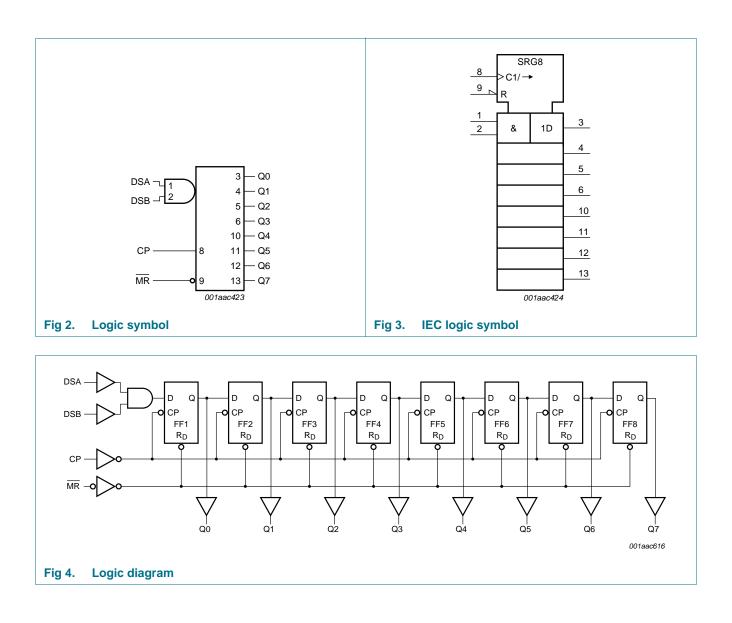
3. Ordering information

| Type number | Package | | | |
|------------------|-------------------|----------|--|----------|
| Type number | Гаскауе | 1 | 1 | 1 |
| | Temperature range | Name | Description | Version |
| 74AHC164-Q100 | | | | |
| 74AHC164D-Q100 | –40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74AHC164PW-Q100 | –40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74AHC164BQ-Q100 | –40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm | SOT762-1 |
| 74AHCT164-Q100 | | | | |
| 74AHCT164D-Q100 | –40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74AHCT164PW-Q100 | –40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74AHCT164BQ-Q100 | –40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm | SOT762-1 |

4. Functional diagram



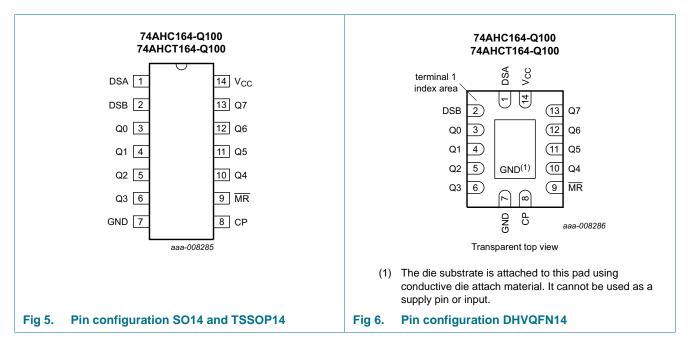
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5. Pinning information

5.1 Pinning



5.2 Pin description

| Table 2. | Pin description | |
|-----------------|-----------------|--|
| Symbol | Pin | Description |
| DSA | 1 | serial data input A |
| DSB | 2 | serial data input B |
| Q0 | 3 | output 0 |
| Q1 | 4 | output 1 |
| Q2 | 5 | output 2 |
| Q3 | 6 | output 3 |
| GND | 7 | ground (0 V) |
| СР | 8 | clock input (LOW-to-HIGH edge-triggered) |
| MR | 9 | master reset input (active LOW) |
| Q4 | 10 | output 4 |
| Q5 | 11 | output 5 |
| Q6 | 12 | output 6 |
| Q7 | 13 | output 7 |
| V _{CC} | 14 | supply voltage |

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6. Functional description

| Operating mode | Control | | Input | | Output | |
|----------------|---------|------------|-------|-----|--------|----------|
| | MR | СР | DSA | DSB | Q0 | Q1 to Q7 |
| Reset (clear) | L | Х | х | х | L | L to L |
| Shift | Н | \uparrow | I | I | L | q0 to q6 |
| | | | I | h | L | q0 to q6 |
| | | | h | I | L | q0 to q6 |
| | | | h | h | Н | q0 to q6 |

Table 3. Function table^[1]

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

 \uparrow = LOW-to-HIGH transition;

X = don't care;

q = lower case letter indicates the state of the referenced input one set-up time prior to the LOW-to-HIGH transition.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|----------------|------|------|
| V _{CC} | supply voltage | | -0.5 | +7.0 | V |
| VI | input voltage | | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | $V_{I} < -0.5 V$ | <u>[1]</u> –20 | - | mA |
| I _{OK} | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V | <u>[1]</u> –20 | +20 | mA |
| I _O | output current | $V_{O} = -0.5 \text{ V}$ to ($V_{CC} + 0.5 \text{ V}$) | -25 | +25 | mA |
| l _{cc} | supply current | | - | +75 | mA |
| I _{GND} | ground current | | -75 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$ | <u>[2]</u> _ | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO14 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.

For TSSOP14 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K. For DHVQFN14 packages: above 60 °C the value of P_{tot} derates linearly at 4.5 mW/K.

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8. Recommended operating conditions

| Table 5. | Operating conditions | | | | | |
|-----------------------|-------------------------------------|---------------------------|-----|-----|-----------------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| 74AHC16 | 64-Q100 | | | | | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V_{CC} = 3.0 V to 3.6 V | - | - | 100 | ns/V |
| | | V_{CC} = 4.5 V to 5.5 V | - | - | 20 | ns/V |
| 74AHCT1 | 64-Q100 | | | | | |
| V _{CC} | supply voltage | | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | V_{CC} = 4.5 V to 5.5 V | - | - | 20 | ns/V |
| | | | | | | |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | 25 °C | | -40 °C 1 | to +85 °C | –40 °C to +125 °C | | Unit |
|----------------------------|----------------|---|------|-------|------|----------|-----------|-------------------|------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74AHC1 | 64-Q100 | | | | | | | 1 | 1 | |
| V _{IH} HIGH-level | | V _{CC} = 2.0 V | 1.5 | - | - | 1.5 | - | 1.5 | - | V |
| | input voltage | V _{CC} = 3.0 V | 2.1 | - | - | 2.1 | - | 2.1 | - | V |
| | | V _{CC} = 5.5 V | 3.85 | - | - | 3.85 | - | 3.85 | - | V |
| V _{IL} LOW-level | | V _{CC} = 2.0 V | - | - | 0.5 | - | 0.5 | - | 0.5 | V |
| | input voltage | V _{CC} = 3.0 V | - | - | 0.9 | - | 0.9 | - | 0.9 | V |
| | | V _{CC} = 5.5 V | - | - | 1.65 | - | 1.65 | - | 1.65 | V |
| V _{OH} H | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | $I_{O} = -50 \ \mu A; \ V_{CC} = 2.0 \ V$ | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | $I_{O} = -50 \ \mu A; \ V_{CC} = 3.0 \ V$ | 2.9 | 3.0 | - | 2.9 | - | 2.9 | - | V |
| | | I_{O} = -50 μ A; V_{CC} = 4.5 V | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.58 | - | - | 2.48 | - | 2.40 | - | V |
| | | $I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.94 | - | - | 3.80 | - | 3.70 | - | V |
| V _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | $I_{O} = 50 \ \mu A; \ V_{CC} = 2.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_{O} = 50 \ \mu A; \ V_{CC} = 3.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 50 \ \mu A; V_{CC} = 4.5 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I_{O} = 4.0 mA; V_{CC} = 3.0 V | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| | | I _O = 8.0 mA; V _{CC} = 4.5 V | - | - | 0.36 | - | 0.44 | - | 0.55 | V |

74AHC_AHCT164_Q100

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| Symbol | Parameter | Conditions | | 25 °C | | –40 °C [∙] | to +85 °C | –40 °C t | o +125 °C | Unit |
|----------------------------|-----------------------------|---|------|-------|------|---------------------|-----------|----------|-----------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | 1 |
| I | input leakage current | $V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$ | - | - | 0.1 | - | 1.0 | - | 2.0 | μA |
| сс | supply current | $\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } GND; \ I_{O} = 0 \ A; \\ V_{CC} = 5.5 \ V \end{array}$ | - | - | 4.0 | - | 40 | - | 80 | μA |
| Cı | input capacitance | | - | 3 | 10 | - | - | - | - | pF |
| 74AHCT | 164-Q100 | | | | | | | | | |
| V _{IH} | HIGH-level input voltage | V_{CC} = 4.5 V to 5.5 V | 2.0 | - | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V_{CC} = 4.5 V to 5.5 V | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| V _{OH} HIGH-level | | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | I _O = -50 μA | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I _O = -8.0 mA | 3.94 | - | - | 3.80 | - | 3.70 | - | V |
| V _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | I _O = 50 μA | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I _O = 8.0 mA | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| I | input leakage current | $V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$ | - | - | 0.1 | - | 1.0 | - | 2.0 | μA |
| l _{cc} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V | - | - | 4.0 | - | 40 | - | 80 | μΑ |
| ∆l _{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other pins at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | - | 1.35 | - | 1.5 | - | 1.5 | mA |
| CI | input capacitance | | - | 3 | 10 | - | - | - | - | pF |

Table 6. Static characteristics ... continued

8-bit serial-in/parallel-out shift register

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see <u>Figure 10</u>.

| Symbol | Parameter | Conditions | | | 25 °C | | −40 °C | to +85 °C | -40 °C t | to +125 °C | Unit |
|--------------------------|--|--|-----|-----|----------------------|------|---------------|-----------|----------|------------|------|
| | | | | Min | Typ <mark>[1]</mark> | Max | Min | Max | Min | Max | |
| 74AHC1 | 64-Q100 | | | | | | | | | | |
| t _{pd} | propagation | CP to Qn; see Figure 7 | [2] | | | | | | | | |
| | delay | V_{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 6.5 | 12.8 | 1.0 | 15.0 | 1.0 | 16.0 | ns |
| | | C _L = 50 pF | | - | 9.3 | 16.3 | 1.0 | 18.5 | 1.0 | 20.5 | ns |
| | | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 4.5 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | | C _L = 50 pF | | - | 6.4 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns |
| | | MR to Qn; see Figure 8 | [3] | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 5.3 | 12.8 | 1.0 | 15.0 | 1.0 | 16.0 | ns |
| | C _L = 50 pF | | - | 7.6 | 16.3 | 1.0 | 18.5 | 1.0 | 20.5 | ns | |
| | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | | |
| | C _L = 15 pF | | - | 4.0 | 8.6 | 1.0 | 10.0 | 1.0 | 11.0 | ns | |
| | | C _L = 50 pF | | - | 5.8 | 10.6 | 1.0 | 12.0 | 1.0 | 13.5 | ns |
| f _{max} maximum | maximum | see Figure 7 | | | | | | | | | |
| | frequency | V_{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | | 80 | 125 | - | 65 | - | 50 | - | MHz |
| | | C _L = 50 pF | | 50 | 75 | - | 45 | - | 35 | - | MHz |
| | | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | 125 | 175 | - | 105 | - | 85 | - | MHz |
| | | C _L = 50 pF | | 85 | 115 | - | 75 | - | 65 | - | MHz |
| t _W | pulse width | CP HIGH or LOW; see Figure 7 | | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | V_{CC} = 4.5 V to 5.5 V | | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{WL} | pulse width | MR; see Figure 8 | | | | | | | | | |
| | LOW | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| | | V_{CC} = 4.5 V to 5.5 V | | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{su} | set-up time | DSA, DSB to CP; see Figure 9 | | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | 5.0 | - | - | 6.0 | - | 6.0 | - | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 4.5 | - | - | 4.5 | - | 4.5 | - | ns |
| t _h | hold time | DSA, DSB to CP; see Figure 9 | | | | | | | | | |
| | | V _{CC} = 3.0 V to 3.6 V | | 1.5 | - | - | 1.5 | - | 1.5 | - | ns |
| | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 2.0 | - | - | 2.0 | - | 2.0 | - | ns | |

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| Symbol | Parameter | Conditions | | | 25 °C | | –40 °C | to +85 °C | –40 °C t | to +125 °C | Unit |
|------------------|-------------------------------------|---|------------|-----|--------|------|--------|-----------|----------|------------|------|
| | | | | Min | Typ[1] | Max | Min | Max | Min | Max | |
| t _{rec} | recovery | MR to CP; see Figure 8 | | | | | | | | | |
| | time | V_{CC} = 3.0 V to 3.6 V | | 2.5 | - | - | 2.5 | - | 2.5 | - | ns |
| | V_{CC} = 4.5 V to 5.5 V | | 2.5 | - | - | 2.5 | - | 2.5 | - | ns | |
| C _{PD} | power dissipation capacitance | $f_i = 1 \text{ MHz}; V_1 = \text{GND to } V_{\text{CC}}$ | <u>[4]</u> | - | 48 | - | - | - | - | - | pF |
| 74AHCT | 164-Q100; V _C | _C = 4.5 V to 5.5 V | | | | | | | | | |
| t _{pd} | | CP to Qn; see Figure 7 | [2] | | | | | | | | |
| | delay | C _L = 15 pF | | - | 3.4 | 9.0 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| | | C _L = 50 pF | | - | 4.9 | 11.0 | 1.0 | 12.5 | 1.0 | 14.0 | ns |
| | | MR to Qn; see Figure 8 | [3] | | | | | | | | |
| | | C _L = 15 pF | | - | 3.5 | 8.6 | 1.0 | 10.0 | 1.0 | 11.0 | ns |
| | | C _L = 50 pF | | - | 5.0 | 10.6 | 1.0 | 12.0 | 1.0 | 13.5 | ns |
| f _{max} | maximum | see Figure 7 | | | | | | | | | |
| | frequency | C _L = 15 pF | | 125 | 175 | - | 105 | - | 85 | - | MH |
| | | C _L = 50 pF | | 85 | 115 | - | 75 | - | 65 | - | MH |
| t _W | pulse width | CP HIGH or LOW; see <u>Figure 7</u> | | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{WL} | pulse width LOW | MR; see Figure 8 | | 5.0 | - | - | 5.0 | - | 5.0 | - | ns |
| t _{su} | set-up time | DSA, DSB to CP; see <u>Figure 9</u> | | 4.5 | - | - | 4.5 | - | 4.5 | - | ns |
| t _h | hold time | DSA, DSB to CP; see <u>Figure 9</u> | | 2.0 | - | - | 2.0 | - | 2.0 | - | ns |
| t _{rec} | recovery time | MR to CP; see Figure 8 | | 2.5 | - | - | 2.5 | - | 2.5 | - | ns |
| C _{PD} | power dissipation capacitance | f_i = 1 MHz; V_I = GND to V_{CC} | <u>[4]</u> | - | 51 | - | - | - | - | - | pF |

Table 7. Dynamic characteristics ... continued

[1] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V and V_{CC} = 5.0 V).

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

 $[3] \quad t_{pd} \mbox{ is the same as } t_{PHL} \mbox{ only.}$

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}{}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}{}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

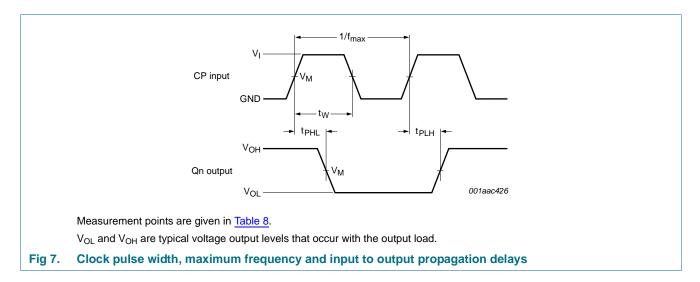
N = number of inputs switching;

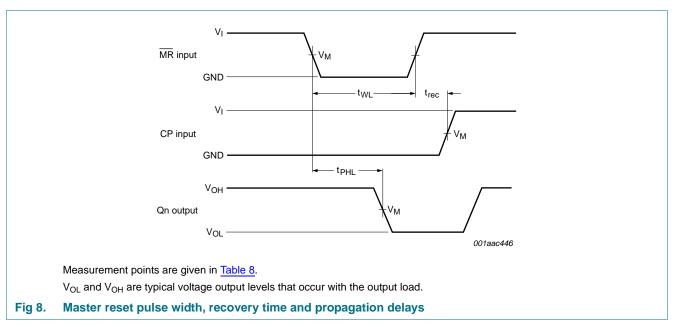
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

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11. Waveforms





8-bit serial-in/parallel-out shift register

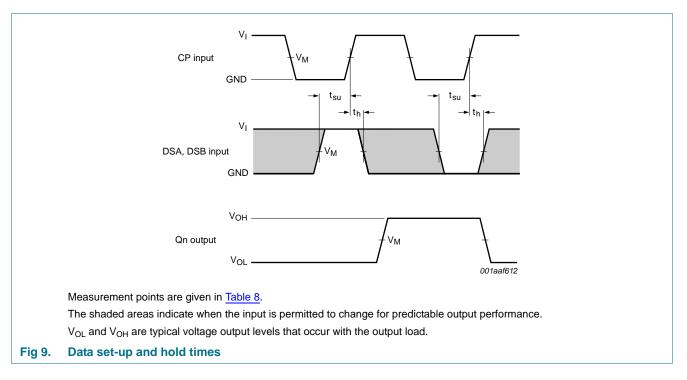


Table 8.Measurement points

| Туре | Input | Output |
|----------------|--------------------|---------------------|
| | V _M | V _M |
| 74AHC164-Q100 | $0.5 	imes V_{CC}$ | $0.5 \times V_{CC}$ |
| 74AHCT164-Q100 | 1.5 V | $0.5 \times V_{CC}$ |

NXP Semiconductors

74AHC164-Q100; 74AHCT164-Q100

8-bit serial-in/parallel-out shift register

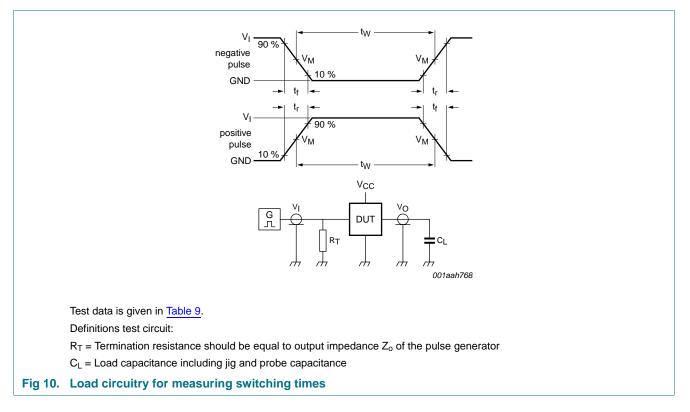


Table 9. Test data

| Туре | Input L | | Load | Test | |
|----------------|-----------------|---------------------------------|--------------|-------------------------------------|--|
| | VI | t _r , t _f | CL | | |
| 74AHC164-Q100 | V _{CC} | \leq 3.0 ns | 15 pF, 50 pF | t _{PLH} , t _{PHL} | |
| 74AHCT164-Q100 | 3.0 V | \leq 3.0 ns | 15 pF, 50 pF | t _{PLH} , t _{PHL} | |

8-bit serial-in/parallel-out shift register

12. Package outline

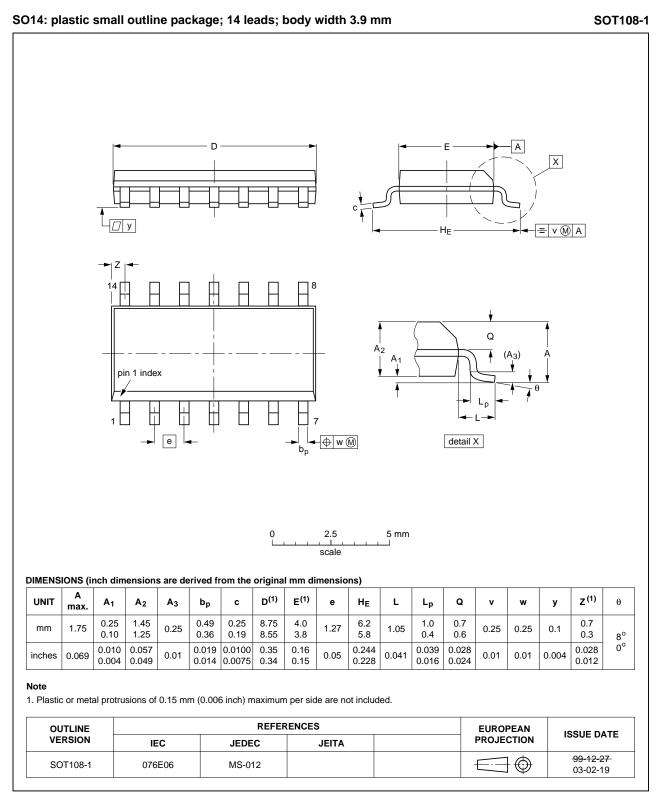


Fig 11. Package outline SOT108-1 (SO14)

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8-bit serial-in/parallel-out shift register

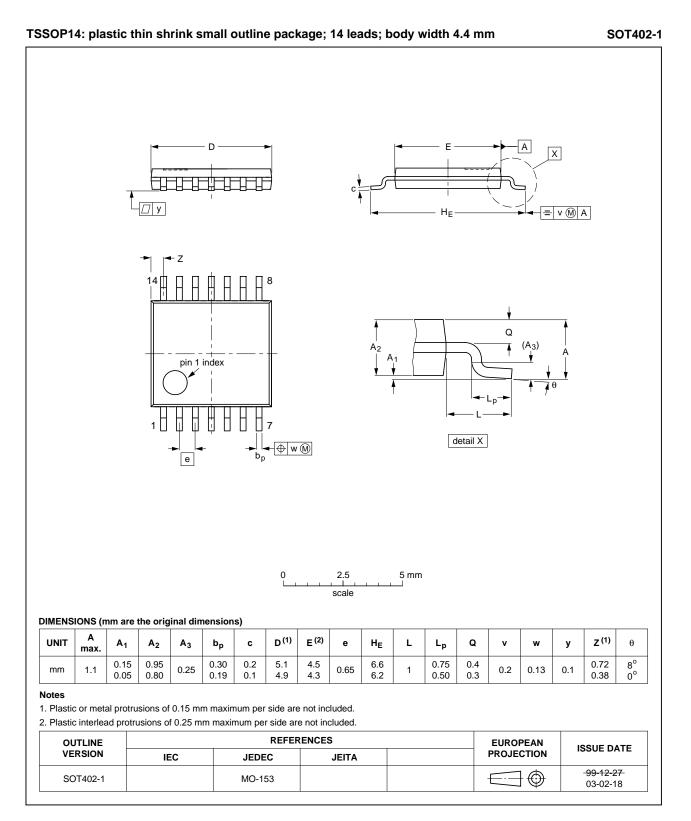
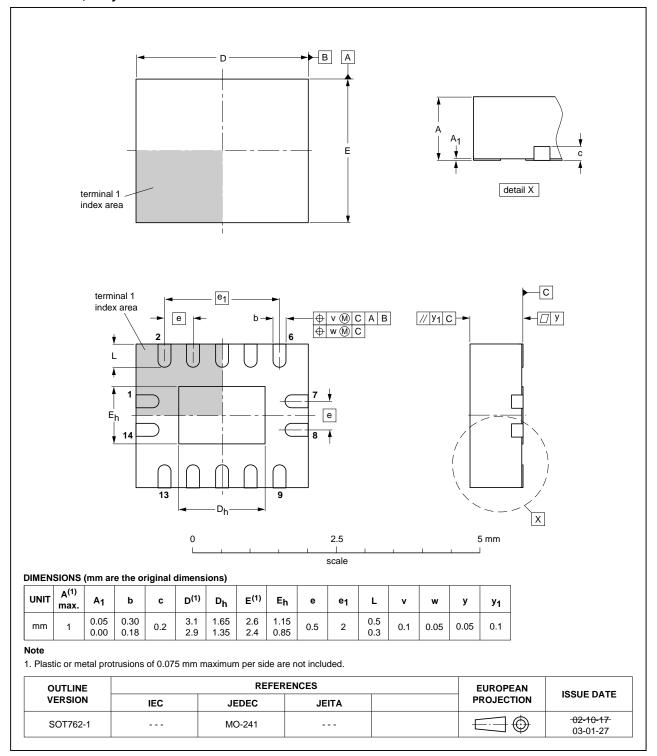


Fig 12. Package outline SOT402-1 (TSSOP14)

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8-bit serial-in/parallel-out shift register



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 13. Package outline SOT762-1 (DHVQFN14)

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13. Abbreviations

| AcronymDescriptionCDMCharged Device ModelCMOSComplementary Metal-Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body ModelMMMachine Model | Table 10. | Abbreviations |
|--|-----------|---|
| CMOSComplementary Metal-Oxide SemiconductorESDElectroStatic DischargeHBMHuman Body Model | Acronym | Description |
| ESD ElectroStatic Discharge HBM Human Body Model | CDM | Charged Device Model |
| HBM Human Body Model | CMOS | Complementary Metal-Oxide Semiconductor |
| | ESD | ElectroStatic Discharge |
| MM Machine Model | HBM | Human Body Model |
| | MM | Machine Model |
| MIL Military | MIL | Military |
| TTL Transistor-Transistor Logic | TTL | Transistor-Transistor Logic |

14. Revision history

| Table 11. Revision history | , | | | |
|------------------------------------|--------------|--------------------|---------------|------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74AHC_AHCT164_Q100 v.1 | 20130705 | Product data sheet | - | - |

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|--------------------------------|-------------------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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